

Single N-Channel MOSFET

DESCRIPTION

SMC3332 is the N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced trench technology devices are well suited for high efficiency fast switching applications, low in-line power loss are needed in small outline surface mount package.

PART NUMBER INFORMATION

SMC 3332 S - TR G
 a b c d e

a : Company name.
 b : Product Serial number.
 c : Package code S: SOT-23L
 d : Handling code TR: Tape&Reel
 e : Green produce code G: *RoHS Compliant*

FEATURES

$V_{DS} = 30V$, $I_D = 5.6A$

$R_{DS(ON)} = 22m\Omega (Typ.) @ V_{GS} = 10V$

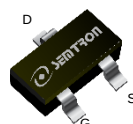
$R_{DS(ON)} = 26m\Omega (Typ.) @ V_{GS} = 4.5V$

$R_{DS(ON)} = 38m\Omega (Typ.) @ V_{GS} = 2.5V$

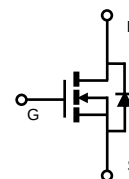
- ◆ Fast switch
- ◆ 2.5V Low gate drive applications

APPLICATIONS

- ◆ Hand-Held Instruments
- ◆ Load Switch
- ◆ LED Applications



SOT-23L



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-Source Voltage	30	V
V_{GSS}	Gate-Source Voltage	± 12	V
I_D	Continuous Drain Current	$T_A = 25^\circ C$	5.6
		$T_A = 70^\circ C$	4.5
I_{DM}	Pulsed Drain Current ^A	23	A
I_{AS}	Avalanche Current ^A	8	A
E_{AS}	Single Pulse Avalanche energy $L=0.1mH$ ^{AD}	3.2	mJ
P_D	Power Dissipation ^B	$T_A = 25^\circ C$	1.4
		$T_A = 70^\circ C$	0.9
T_J	Operation Junction Temperature	-55/150	$^\circ C$
T_{STG}	Storage Temperature Range	-55/150	$^\circ C$

THERMAL RESISTANCE

Symbol	Parameter	Typ	Max	Units
$R_{\theta JA}$	Thermal Resistance Junction to Ambient ^B	$t \leq 10s$	80	$^\circ C/W$
	Thermal Resistance Junction to Ambient ^{BC}	Steady-State	120	

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise noted)

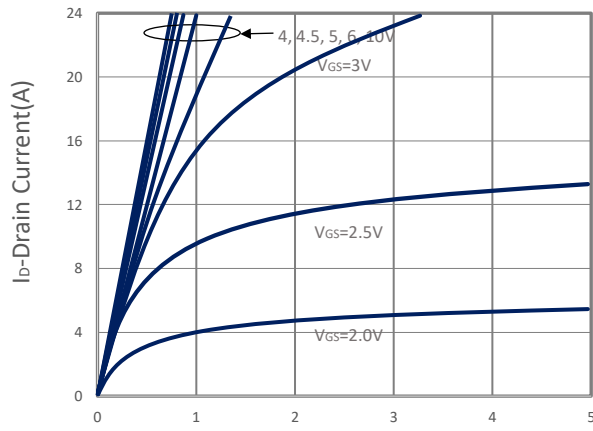
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Parameters						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	30			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.5	0.7	1	V
I _{GSS}	Gate Leakage Current	V _{DS} =0V, V _{GS} =±12V			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V, T _J =25°C			1	μA
		V _{DS} =24V, V _{GS} =0V, T _J =75°C			10	
R _{DS(ON)}	Drain-source On-Resistance	V _{GS} =10V, I _D =5.6A		22	26	mΩ
		V _{GS} =4.5V, I _D =4.5A		26	32	
		V _{GS} =2.5V, I _D =3.2A		38	48	
G _{fs}	Forward Transconductance	V _{DS} =10V, I _D =3A		7		S
Diode Characteristics						
V _{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V		0.75	1	V
I _S	Continuous Source Current				2.8	A
Dynamic and Switching Parameters						
Q _g (10V)	Total Gate Charge	V _{DS} =15V, V _{GS} =10V, I _D =5A		13.5	18.9	nC
Q _g (4.5V)	Total Gate Charge			6.6	8.9	
Q _{gs}	Gate-Source Charge			1.5	3.5	
Q _{gd}	Gate-Drain Charge			1.7	2.4	
C _{iss}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz		585		pF
C _{oss}	Output Capacitance			42		
C _{rss}	Reverse Transfer Capacitance			35		
t _{d(on)}	Turn-On Time	V _{DD} =15, V _{GEN} =10V R _G =6Ω, I _D =1A		4.25	8.1	nS
t _r				15.8	30	
t _{d(off)}	Turn-Off Time			31	59	
t _f				9.2	17	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

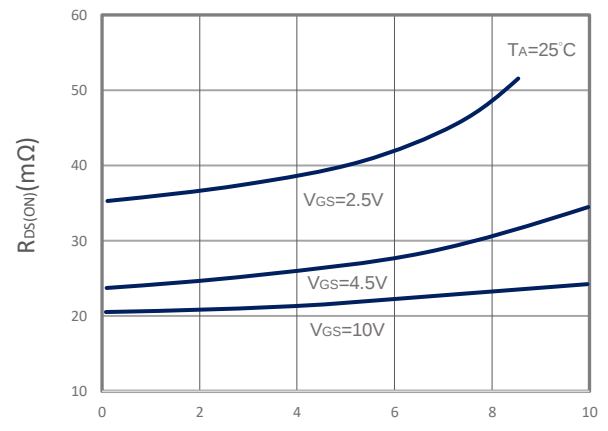
- Pulsed width limited by maximum junction temperature, T_{J(MAX)}=150°C.
- The value of R_{θJA} is measured with the device mounted on 1in2 FR-4 board in a still air environment with maximum junction temperature T_{J(MAX)}=150°C (initial temperature T_A=25°C).
- T_{J(MAX)}=150°C, using junction-to-case thermal resistance (R_{θJC}) is more useful in additional heat sinking is used.
- The EAS data shows Maximum, tested and pulse width limited by maximum..

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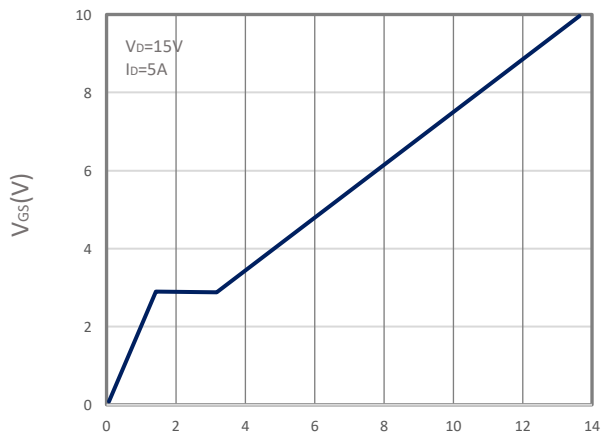
TYPICAL CHARACTERISTICS



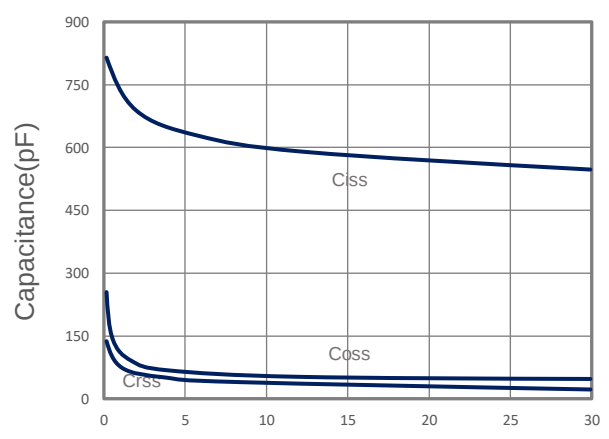
Output Characteristics



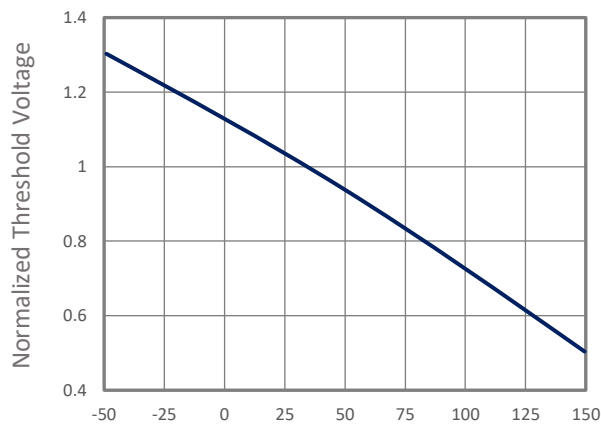
Drain-Source On Resistance



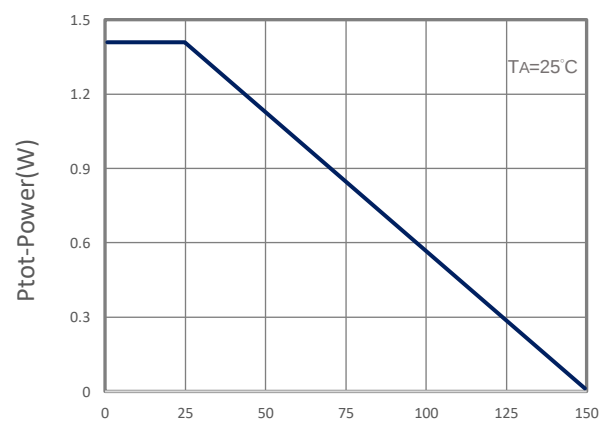
Gate Charge



Capacitance

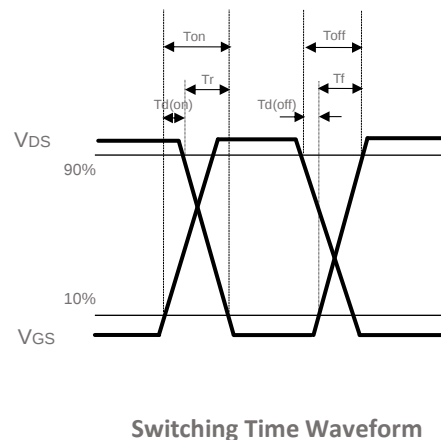
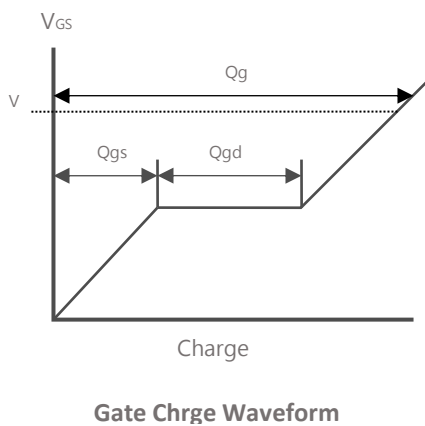
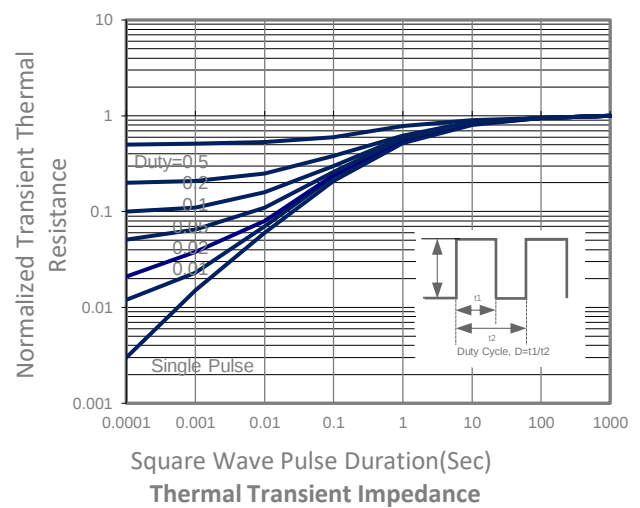
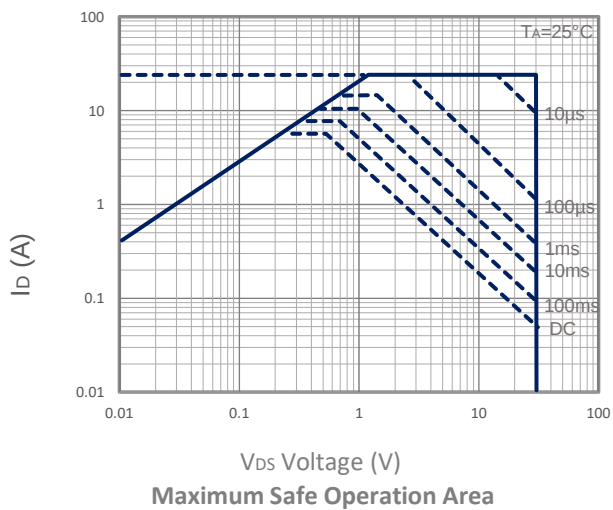
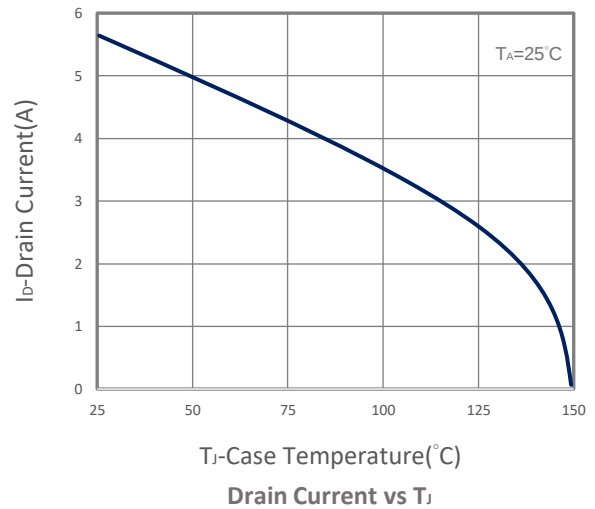
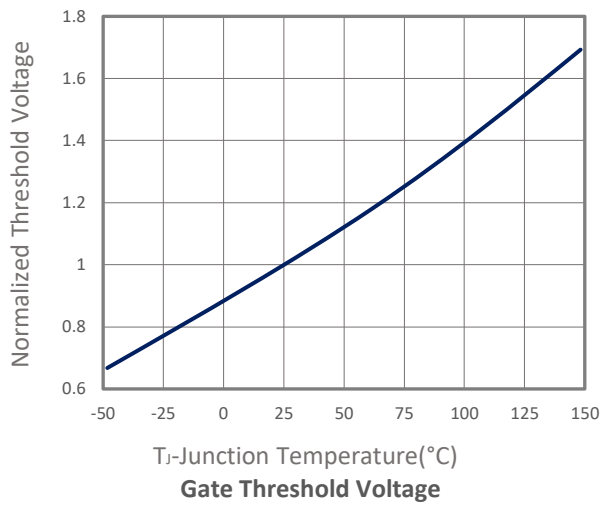


Gate Threshold Voltage

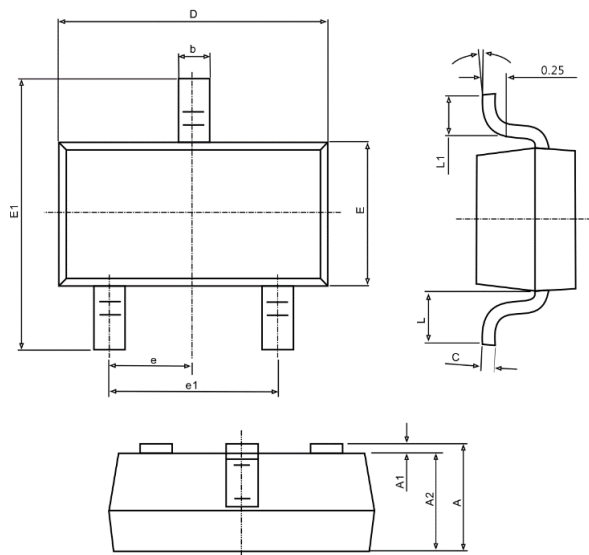


Power Dissipation

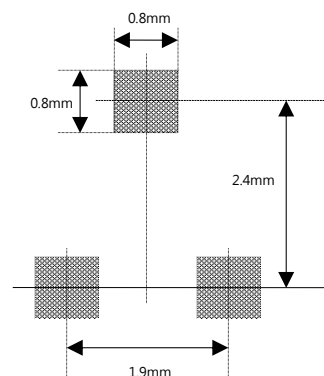
TYPICAL CHARACTERISTICS



■ SOT-23L PACKAGE DIMENSIONS



Recommended Minimum Pad(mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.000	1.300	0.039	0.049
A1	0.000	0.100	0.000	0.004
A2	1.000	1.200	0.039	0.047
b	0.300	0.500	0.012	0.020
c	0.047	0.207	0.002	0.008
D	2.800	3.000	0.110	0.118
E	1.500	1.700	0.059	0.067
E1	2.600	3.000	0.102	0.118
e	0.950 TYP.		0.037 TYP.	
e1	1.900 TYP.		0.075 TYP.	
L1	0.250	0.550	0.010	0.022
θ	0°	8°	0°	8°